APPLICA	BLE STAN	DARD									
	OPERATING TEMPERATURE RANGE		-35°C TO +85 °C(N	NOTE 1)	STORA TEMPE		RE RANGE		-10°C TO +60°C(N	OTE	3)
RATING	OPERATING HUMIDITY RANGE		20 % TO 80 % (NC	OTE 2)	STORAGE HUMIDITY RA		NGE		40 % TO 70 %(No	3)	
	VOLTAGE		150 V AC			LICABLE NECTOR			DF13-*S-1.250		
	CURRENT		1 A APF			LICABLE CONTACT			DF13(G)-2630SC DF13-3032SCF		,
	1		SPEC	IFICA	TION	IS					
	EM		TEST METHOD				RE	QUI	REMENTS	QT	AT
	RUCTION				,						
	XAMINATION	VISUALLY AND BY MEASURING INSTRUMENT. CONFIRMED VISUALLY.				ACCORDING TO DRAWING.					Х
MARKING										X	X
	IC CHARA									1	1
CONTACT RESISTANCE		100 m A (DC OR 1000 Hz).				30 mΩ MAX.				Х	
INSULATION RESISTANCE		100 V DC.				500 MΩ MIN.				Х	-
VOLTAGE PR	ROOF	500 V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				Х	_
MECHAN	IICAL CHA	RACTI	ERISTICS								
MECHANICA	L OPERATION	50 TIMES INSERTIONS AND EXTRACTIONS.				 CONTACT RESISTANCE: 30 mΩ MAX. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				X	_
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.				 NO ELECTRICAL DISCONTINUITY OF 1μs. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 					_
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.									_
ENVIRO	NMENTAL	CHAR	ACTERISTICS								
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 \rightarrow 5 TO 35 \rightarrow +85 \rightarrow 5 TO 35 °C TIME 30 \rightarrow 10 TO 15 \rightarrow 30 \rightarrow 10 TO 15 min. UNDER 5 CYCLES.				 CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 500 MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 					-
DAMP HEAT		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.								X	_
(STEADY ST	·	1) REFLOW SOLDERING				NO DEFORMATION OF CASE OF EXCESSIVE					
SOLDERING	HEAT	≪REFLOW AREA≫ MAX250°C WITHIN 10 sec MIN 230°C WITHIN 60 sec ≪PREHEATING AREA≫ 170°C to 190°C 60 sec to 120 sec PUT THROUGH IN REFLOW FURNACE TWICE, LEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :350°C, SOLDERING TIME : 3sec. NO STRENGTH ON CONTACT.				LOOSENESS OF THE TERMINALS.				X	_
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE,				SOLDER SHALL COVER A MINIMUM OF					_
REMARKS			±5°C FOR INSERTION DURATION, 3sec.				95 % OF THE SURFACE BEING IMMERSED.				
NOTE1: INCLU NOTE2: NO CO NOTE3: APPLY AFTEF	ONDENSING. 'TO THE CONDI	TION OF LO	SING BY CURRENT. NG TERM STORAGE FOR UNUS DARD, OPERATING TEMPERA						ED FOR INTERIM STOR	AGE [DURING
COUN	T DE	SCRIPTION OF REVISIONS DES		DESIGN	GNED			CHECKED		ATE	
Unless otherwise specified, refe			for to IEC 60512			1.0000/50					
Uniess othe	erwise specif	eu, reier to IEO 60512.				APPE			_		04.05
							CHECKE		TS.FUKUSHIMA		04.05
						DESIGNED			TS.KUMAZAWA		
Note OT:O	ualification To	et AT·Ao	surance Test Y-Annlicable Test					N	MK.INOUE 18. ELC-083664-76-0		04.05 \()
					PART N	RAWING NO.			DF13-*P-1.25V(76)		
HS		SPECIFICATION SHEET							`		4 /4
	HIK	HIROSE ELECTRIC CO., LTD.				NO.		CL536			1/1